



1fw
B

MS ISSUE FEE
AMENDMENT UNDER 37 C.F.R. § 1.312
EXPEDITED PROCEDURE
EXAMINING GROUP 2814

PATENT
0763-0173P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Dong K. SOHN et al. Conf.: 9674
Appl. No.: 10/620,608 Group: 2814
Filed: July 17, 2003 Examiner: Long Pham
For: METHOD OF FORMING FILM FOR REDUCED OHMIC CONTACT
RESISTANCE AND TERNARY PHASE LAYER AMORPHOUS
DIFFUSION BARRIER

LARGE ENTITY TRANSMITTAL FORM
FOR AMENDMENT UNDER 37 C.F.R. § 1.312

MS ISSUE FEE

Commissioner for Patents
P.O. Box 1450
Alexandria, VA 22313-1450

November 17, 2004

Sir:

Transmitted herewith is an amendment in the above-identified application.

The enclosed document is being transmitted via the Certificate of Mailing provisions of 37 C.F.R. § 1.8.

The enclosed document is being transmitted via facsimile.

The fee has been calculated as shown below:

	CLAIMS REMAINING AFTER AMENDMENT	HIGHEST NUMBER PREVIOUSLY PAID FOR			PRESENT EXTRA	RATE	ADDITIONAL FEE
TOTAL	5	-	20	=	0	\$ 18	\$ 0.00
INDEPENDENT	2	-	3	=	0	\$ 88	\$ 0.00
<input type="checkbox"/> FIRST PRESENTATION OF A MULTIPLE DEPENDENT CLAIM						\$300	\$ 0.00
						TOTAL	\$ 0.00

Petition for () month(s) extension of time pursuant to 37 C.F.R. §§ 1.17 and 1.136(a). \$0.00 for the extension of time.

No fee is required.

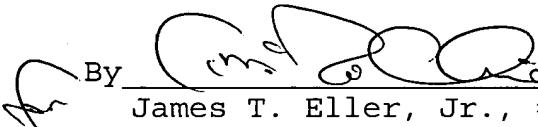
Check(s) in the amount of \$0.00 is(are) enclosed.

Please charge Deposit Account No. 02-2448 in the amount of \$0.00. This form is submitted in triplicate.

If necessary, the Commissioner is hereby authorized in this, concurrent, and future replies, to charge payment or credit any overpayment to Deposit Account No. 02-2448 for any additional fees required under 37 C.F.R. §§1.16 or 1.17; particularly, extension of time fees.

Respectfully submitted,

BIRCH, STEWART, KOLASCH & BIRCH, LLP


By _____ #42,874
James T. Eller, Jr., #39,538

JTE/CAM:cms
0763-0173P

P.O. Box 747
Falls Church, VA 22040-0747
(703) 205-8000

Attachment(s)



MS ISSUE FEE
PATENT
0763-0173P

IN THE U.S. PATENT AND TRADEMARK OFFICE

Applicant: Dong K. SOHN et al. Conf.: 9674

Appl. No.: 10/620,608 Group: 2814

Filed: July 17, 2003 Examiner: Long PHAM

For: METHOD OF FORMING FILM FOR REDUCED OHMIC
CONTACT RESISTANCE AND TERNARY PHASE LAYER
AMORPHOUS DIFFUSION BARRIER

AMENDMENT UNDER 37 C.F.R. § 1.312

MS ISSUE FEE

November 17, 2004

Commissioner of Patents
P.O. Box 1450
Alexandria, VA 22313-1450

Sir:

Further to the Notice of Allowance mailed November 15, 2004,
the following amendments and remarks are respectfully submitted in
connection with the above-identified application.

This amendment includes amendments to the specification,
claims and remarks.